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THICKNESS DEPENDENCE OF THE SEB BIAS THRESHOLD IN FS-LASER BASED MORTALITY STUDY ON LGAD FROM DIFFERENT PRODUCERS

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Study on irradiated LGADs - Fall 2021 campaign at ELI

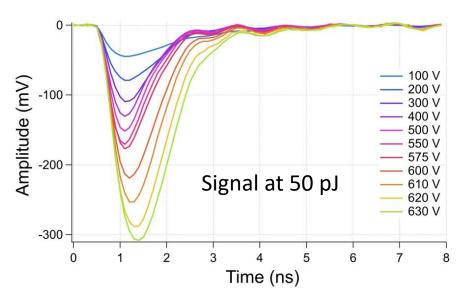
The first set of samples: 6 LGADs wire bonded in Ljubljana and sent by Gregor

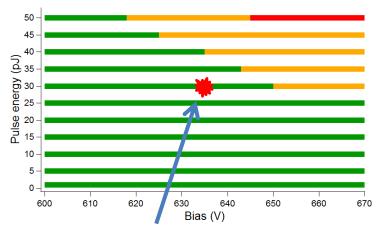
directly to ELI (HPK, FBK)

Sensor typeor	Fluence	Thickness	Pad	Nominal max. bias	Damage	Performed experiments
HPK-P2 W36 LGAD	1.5e15	50 um	2x2 array	650 V	SPA at 635V/30 pJ (unintentional breakdown)	Front - SPA
FBK UFSD3.2 W18 LGAD C+B	1.5e15	45 um	2x2 array	~550 V	No damage	Front – SPA (+ guard ring) Back - SPA Front – TPA
FBK UFSD3.2 W18 LGAD C+B	2.5e15	45 um	2x2 array	~550 V	SPA at 545V/1 pJ (unintentional breakdown)	No data
HPK-P1 W4 LGAD (type 1.2)	1.5e15	35 um	2x2 array	~400 V (in practice ~550 V)	No damage	Front – SPA (+ interpad) Back - SPA Front – TPA Back - TPA
HPK-P1 W4 LGAD (type 1.2)	2.25e15	35 um	single	~400 V (in practice ~550 V)	TPA at 530V /1.45 nJ	Front – SPA (+ guard ring) Back - SPA Front – TPA

Due to time limitations most of studies were performed at laser energy 50 pJ for SPA and equivalent values for TPA studies. Temperature of the samples for all measurements were kept at -25 °C.

HPK-P2 W36 LGAD (1.5e15 50 um 2x2 array) Front SPA, 800 nm





Breakdown in the "safe" region asdefined in previous study

This sample is from the same wafer we have already tested in our previous study (W36 LGAD 1.5e15).

This time we observed:

- ✓ higher leak current at the same bias & higher amplitude signal at the same laser power for bias > 600 V (the most probable due to higher capacity 2x2 LGAD area)
- √ breakdown at lower laser power and bias (30 pJ/635 V vs 50 pJ/645 V previously)
- √ no visible damage on the pad after breakdown
- it has to be inspected by microscope and further investigate in order to demonstrate that sensor died from the same mechanism as before (SEB and the same triggered conditions)

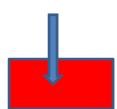
from the same mechanism as before (SEB and the same triggered conditions)

Experimental conditions were the same so maybe something in this sample or wire bonding.

Other samples of the same type are needed to verify these discrepancies. Unfortunately, no backup of the sample so no further studies were performed.

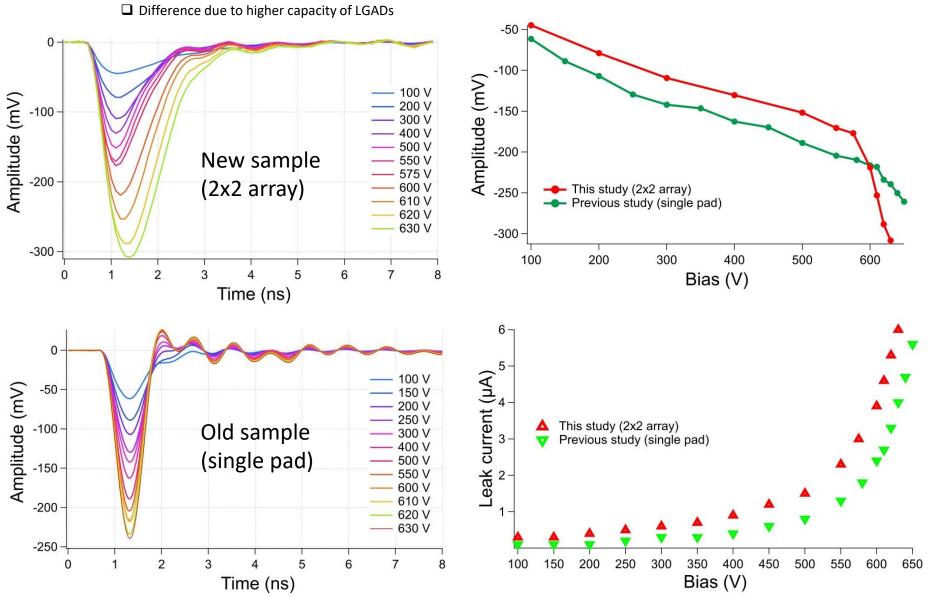
Difficult to justify behavior based on one sample



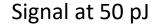


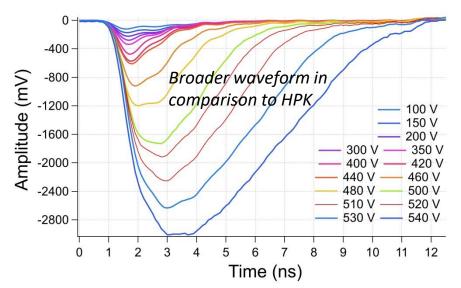
HPK-P2 W36 LGAD (1.5e15 50 um)

Comparison of new sample (2x2 array) with previous one (single pad)



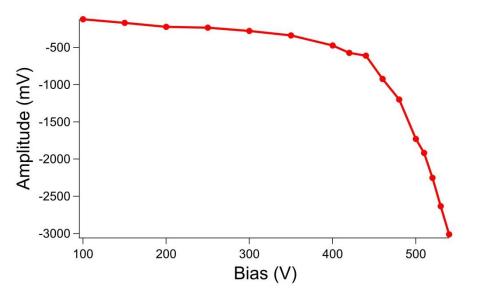
FBK UFSD3.2 W18 LGAD (1.5e15 45 um 2x2 array)

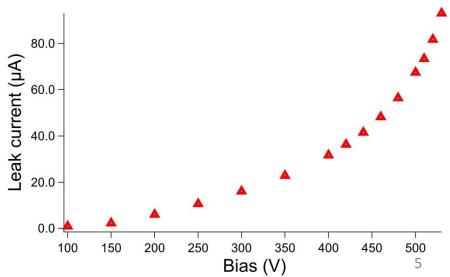




- this sensor has nominal max. bias ~550 V
- waveforms start broadening significantly above 450 V but the signal is stable (no jumping) in all studied range
- Leak current is stable below 550 V
- Leak current jumps rapidly above 0.5 mA at 550V but not irreversible damage happens
- sensor works normally after decreasing bias below 550 V
- rapid jump of current at 550 V occurs also for low pulse energies < 10 pJ</p>

(0.5 mA is a safety limit of our HV power supply so further increase of bias is not possible)





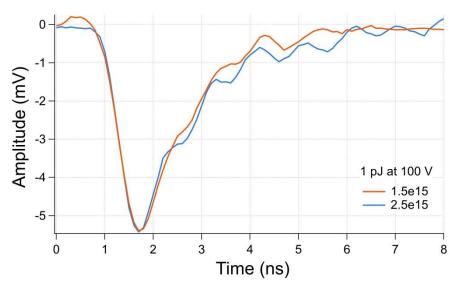
FBK UFSD3.2 W18 LGAD (2.5e15 45 um 2x2 array)

Irreversible damage of the sensor at 545V for 1 pJ pulse energy.

Unfortunately, this sample was **unintentionally damaged** during preliminary studies. On the other hand the first FBK sensor didn't break down at 550 V.

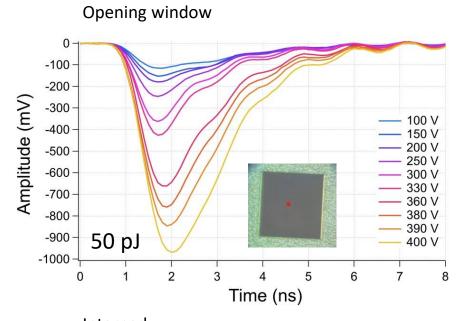
Only one result we managed to get for this sample is single waveform we registered during alignment. Below it's comparison with the first FBK sample (1.5e15).

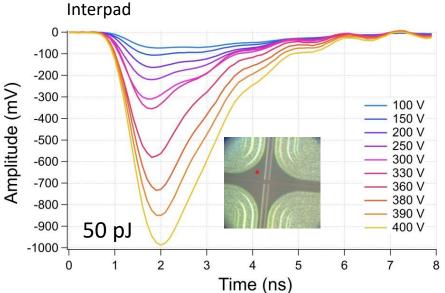
The waveforms for both samples are very similar.



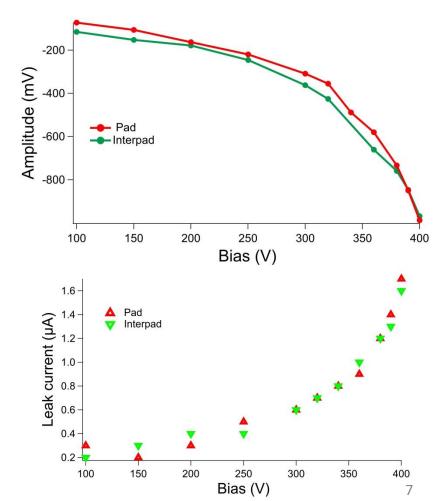
No other data for this sample

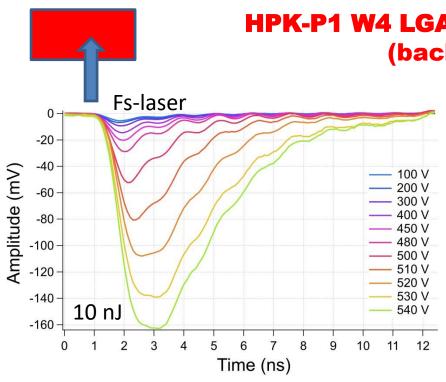
HPK-P1 W4 LGAD (1.5e15 35 um 2x2 array)



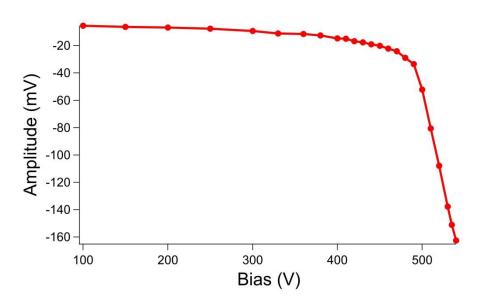


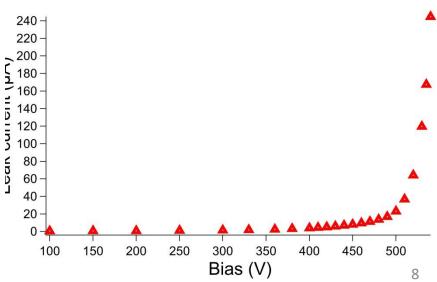
- this sensor has nominal max. bias ~400 V
- the measurements in this range were performed for opening window and for the interpad region
- the results are nearly identical



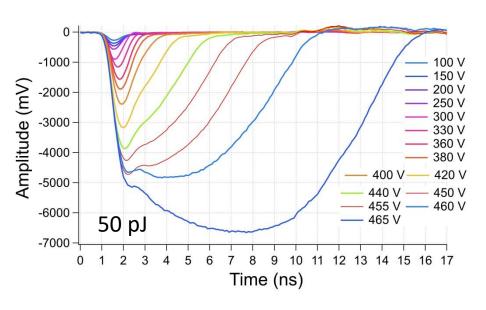


- HPK-P1 W4 LGAD (1.5e15 35 um 2x2 array) (backside illumination)
 - to get a reasonable signal by illumination from the backside much higher pulse energy is necessary
 - more or less one order of magnitude higher pulse energy gives the signal comparable with front illuminated sensor (10 nJ vs 10 pJ)
 - although nominal max. bias for this sensor is ~400 V it turned out that it can survive significantly higher voltage (at least 544 V)
 - the signal became slightly instable (small jumping of amplitude) above 500 V
 - leak current jumps rapidly above 0.5 mA at 544V but not irreversible damage happens

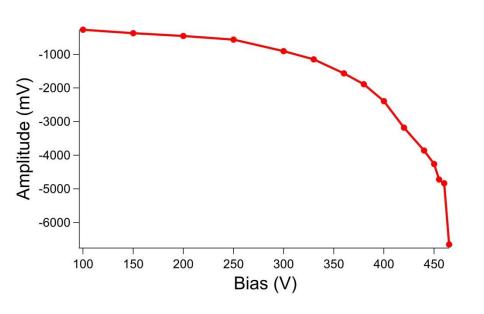


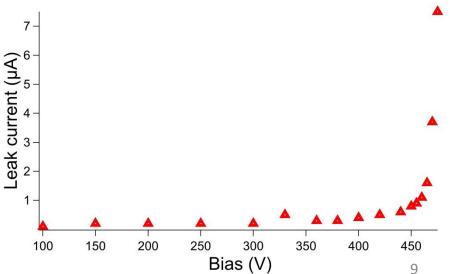


HPK-P1 W4 LGAD (2.25e15 35 um single pad) Frontside

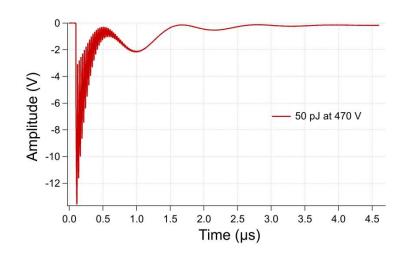


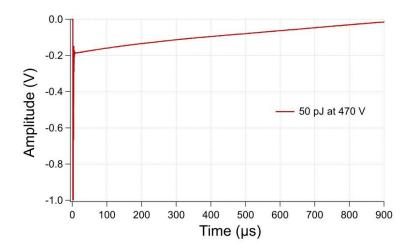
- although nominal max. bias for this sensor is ~400 V it turned out that it can survive higher voltage (at least 505 V)
- the signal became very broad above 420 V
- the signal became slightly instable (small jumping of amplitude) at 450 V
- the signal is highly deformed and extended at 470 V (see next slide)
- above 470 V the signal is too high to be measured
- leak current becomes unstable at 505 V





HPK-P1 W4 LGAD (2.25e15 35 um single pad) (bias above nominal value 400 V)



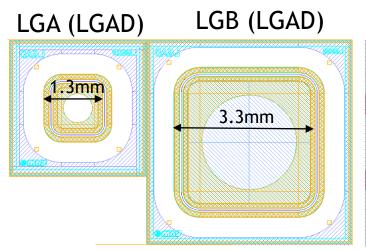


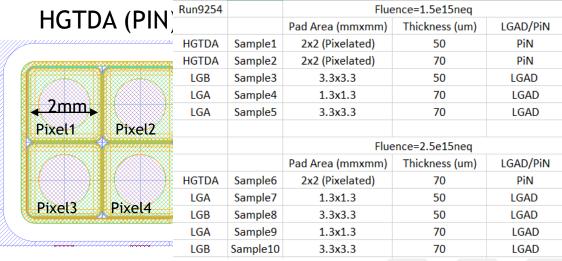
Run9254 \rightarrow 50/70um LGADs & PINs Consejo Superior de Investigaciones Científicas





Devices Run9254









Voltage range (at -20°C)

Devices of this sort have been found to have their mortality at about 600V for thicknesses of 50um (either LGADs, with intrinsic multiplication, or PINs, without), thus they can stand 12V/um (more or less).

For the devices of 70um, it is expected that their mortality occurs beyond 600V $(12V/um \times 70um = 840V)$

Request: If possible, the voltage range should cover a range up to 800-840V at -20°C

Study on irradiated LGADs – CNM samples

Samples: 10 LGADs sent to Prague from CNM and 6 of them wire bonded by Jiri

Sensor type	Fluence	Thickness	Stability threshold	Breakdown
W1 LGAD LGB, 3.5x3.5mm ²	1.5e15	50 um	600 V	615 V
W2 LGAD LGB, 3.5x3.5mm ²	2.5e15	50 um	600 V	> 545 V
PIN (2x2) 3.5x3.5mm ²	1.5e15	70 um	840 V	885 V
W3 LGAD LGB	1.5e15	70 um	840 V	915 V
W3 LGAD LGB	2.5e15	75 um	820 V	> 910 V
W4 PIN 3.3x3.3 mm ²	2.5e15	75 um	900 V	910 V

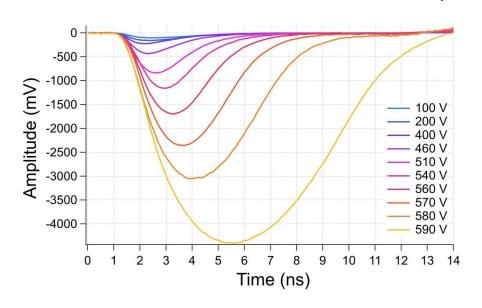
All the samples were illuminated by 50 pJ laser pulses at 800 nm

All the samples were kept at temperature -25 °C

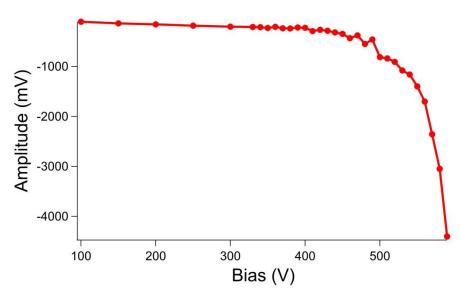
The waveforms of the signal were recorded vs HV bias

Leak current was monitored vs HV bias

W1 LGAD (1.5e15 50 um) LGB, 3.5x3.5 mm²

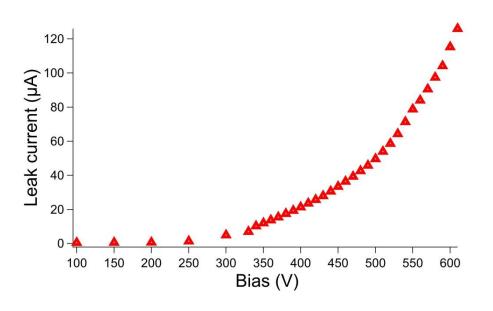


Signal of the sensor vs bias is relatively linear for lower values (up to 400 V). For higher values we observe rapid highly nonlinear increase of the signal amplitude and significant broadening of the waveforms.

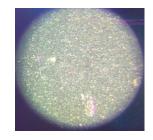




W1 LGAD (1.5e15 50 um):continuation

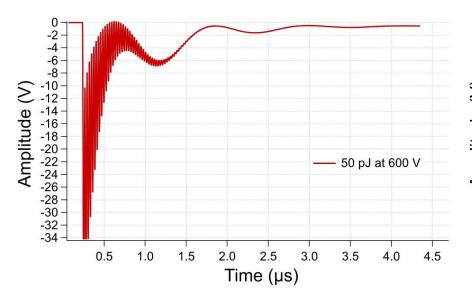


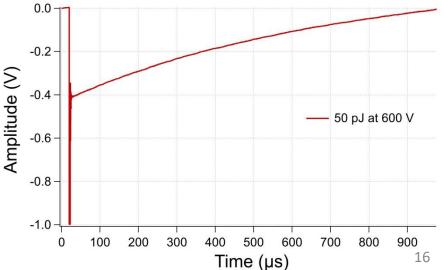
- Signal is stable up to 600 V
- Above 600 V signal becomes unstable (amplitude vary , the waveform is deformed and extended to microsecond scale)
- At 615 V the sensor breaks down irreversibly
- Probably some damage spots appear in the illuminated area after breakdown but further visual inspection with electron microscope is needed (we plan to do it in 1-2 weeks)



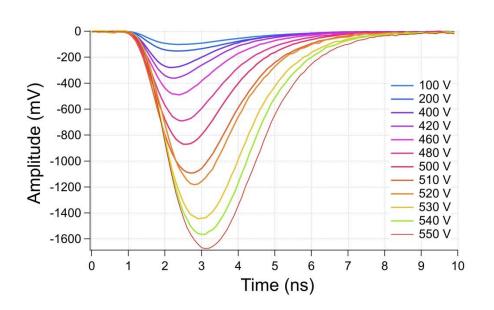
(some spots are visible but not clear in the simple imaging system of the setup)

Example waveforms in unstable region (at 600 V)



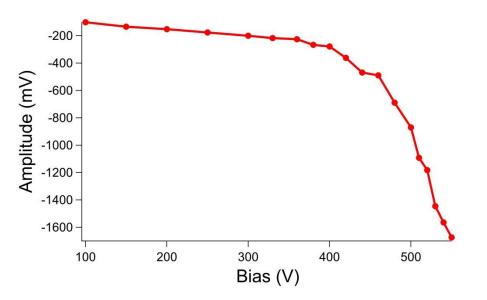


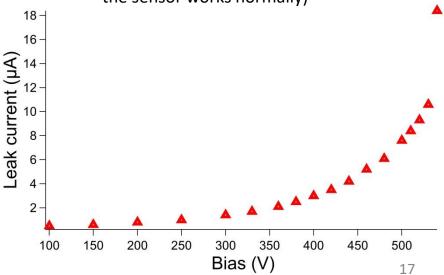
W2 LGAD (2.5e15 50 um) LGB, 3.5x3.5 mm²

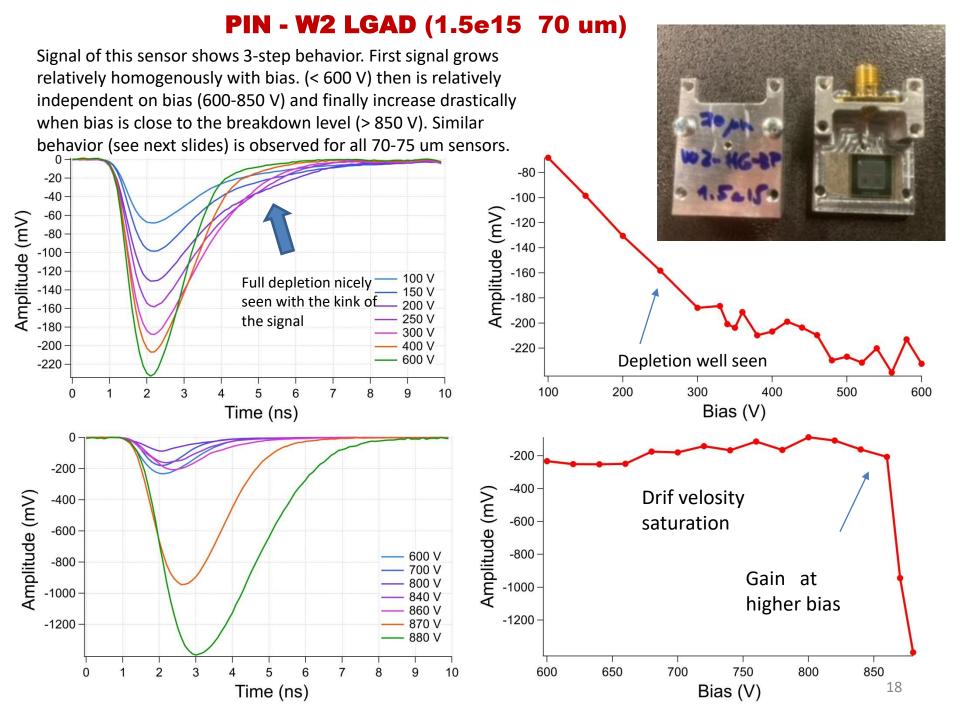




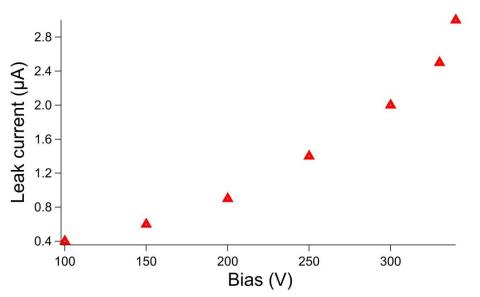
- Signal is stable up to 540 V
- Above 540 V signal becomes slightly unstable (amplitude varies) and the leak current start jumping.
- At 545 V the leak current rapidly jumps above 0.5 mA what is a safety limit of our HV power supply. In such case further increase of bias is not possible in our setup.
- No damage at 545 V (after decreasing the bias the sensor works normally)





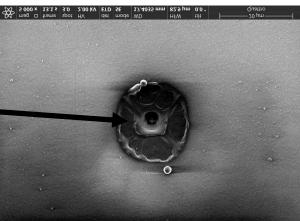


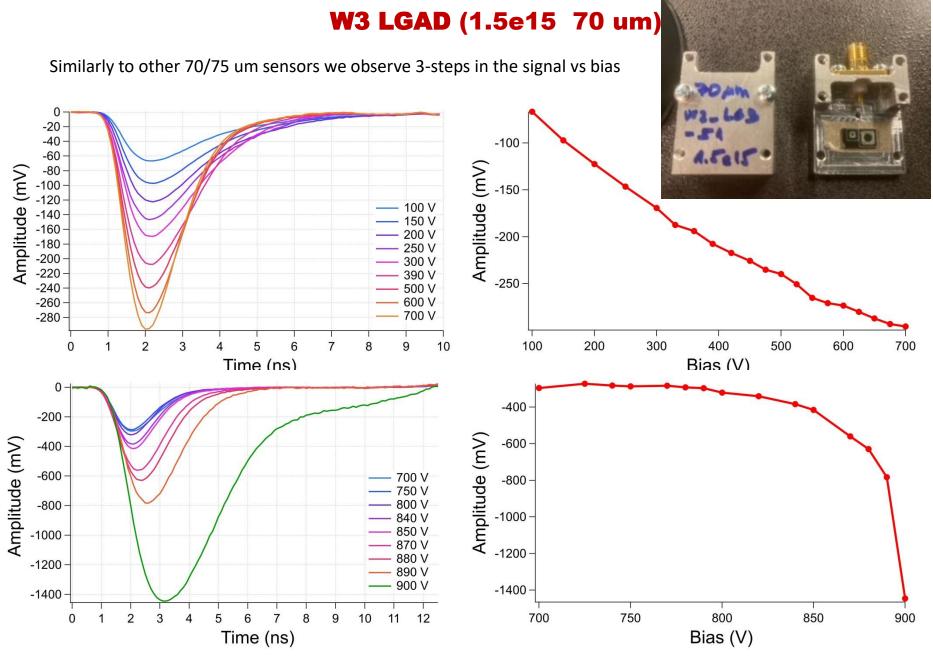
W2 LGAD (1.5e15 70 um) LGM, 3.3x3.3 mm²



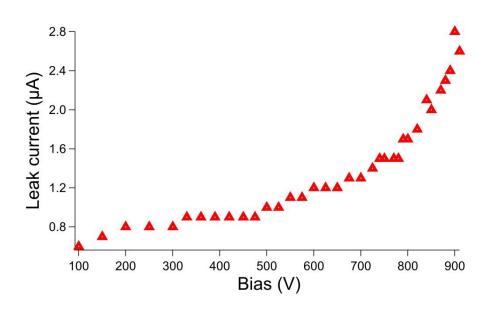
- In this particular sensor the leak current becomes very unstable at relatively low bias 340 V. We observe rapid amplitude jumping between 3 and 90 uA.
- However the current instability is not reflected in the signal and it looks quite stable up to 800 V
- Signal becomes unstable above 800 V (amplitude and broadening vary)
- Irreversible break down occurred at 885 V
- No visible damage in illuminated area

Fatality signature at the same place where illumination was performed (seen in our study as characteristic feature for CNM sesnosr; not HPK)

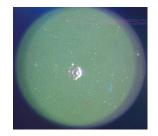




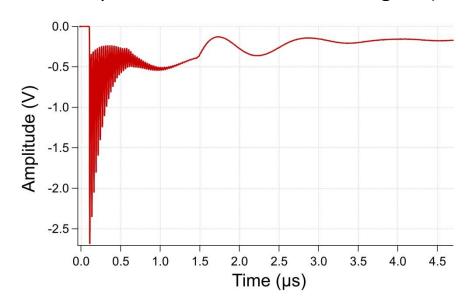
W3 LGAD (1.5e15 70 um)

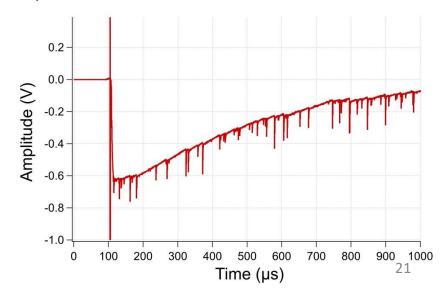


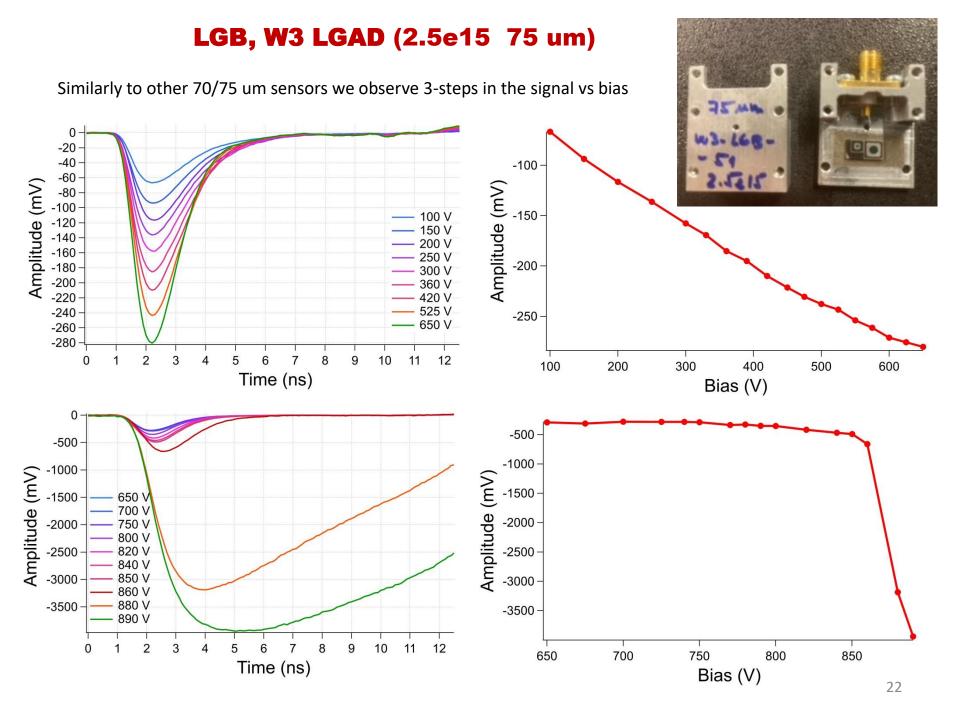
- Signal is stable up to 720 V
- Between 720 and 840 V signal is slightly unstable (small jumping of amplitude)
- Signal is unstable above 840 V (amplitude and broadening vary)
- Irreversible break down occurred at 910 V
- Clear damage spot in the place of illumination



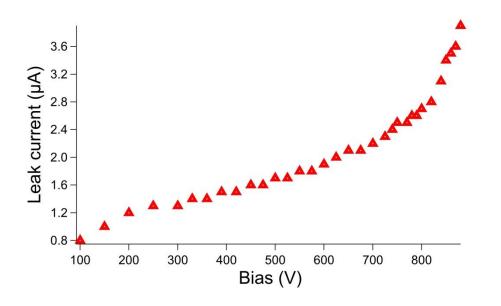
Example waveforms in unstable region (at 900 V)





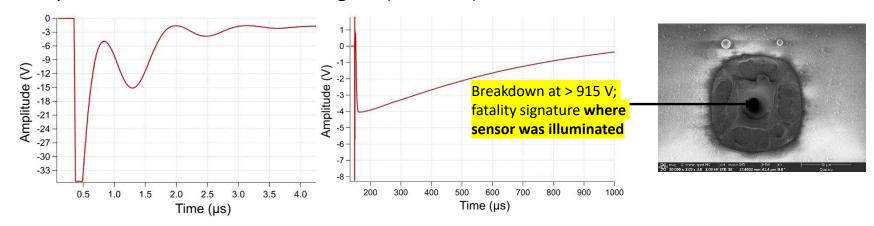


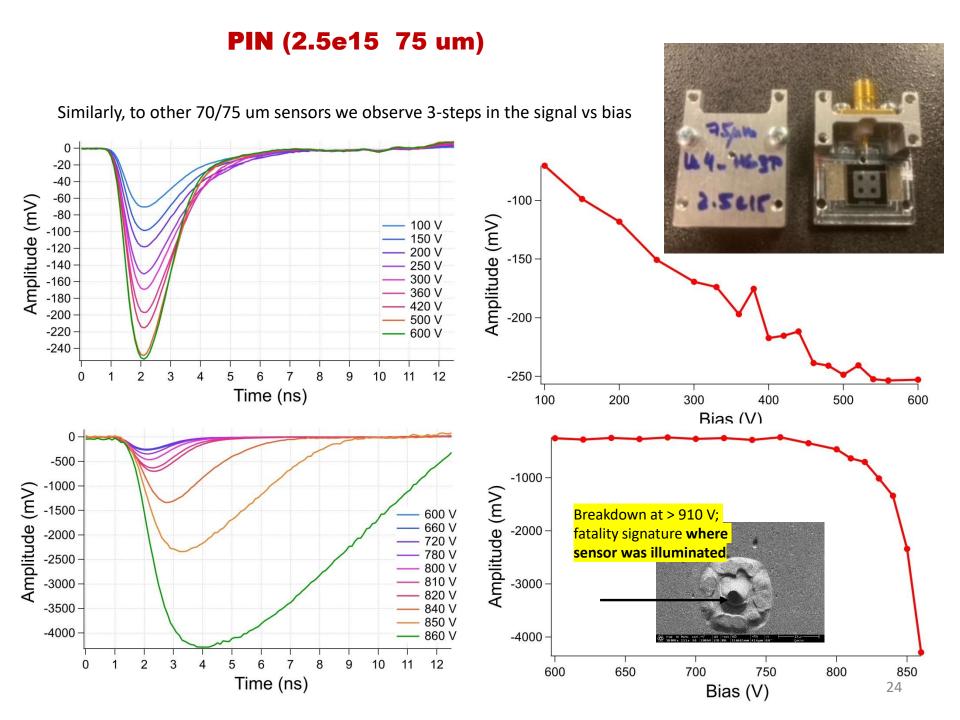
W3 LGAD (2.5e15 75 um)

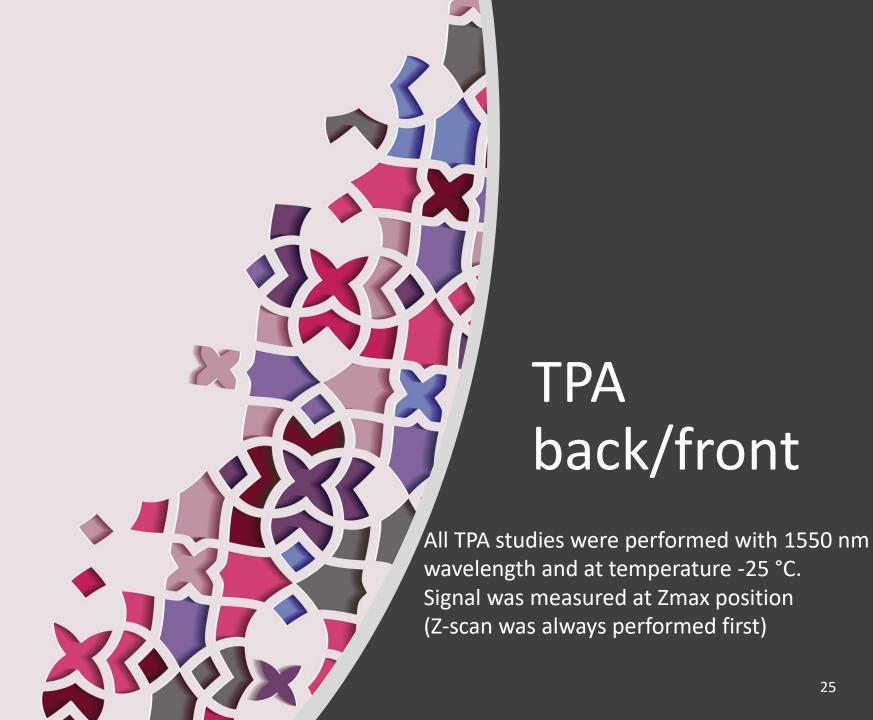


- Signal is stable up to 820 V
- Between 820 and 860 V signal is slightly unstable (small jumping of amplitude)
- Signal is unstable above 860 V (amplitude and broadening vary)
- Leak current becomes unstable at 890 V
- At 915 V signal is too high to be measured
- I could apply higher bias to reach the breakdown and know exact damage threshold but I decided to save this sensor for other studies. However the waveforms recorded at 915 V shows that this value is very close to the breakdown limit.

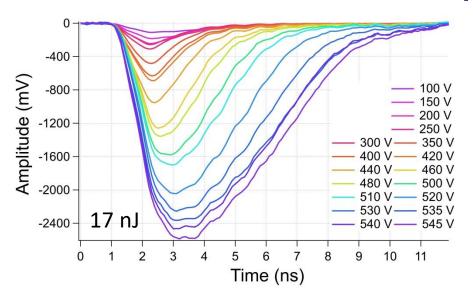
Example waveforms in unstable region (at 915 V)



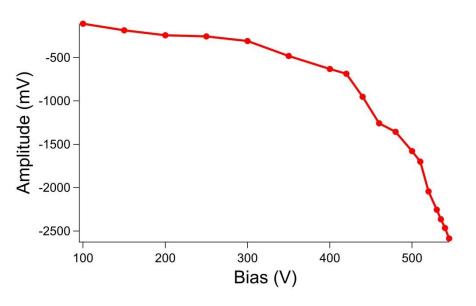


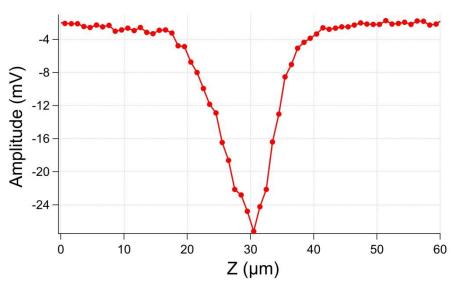


FBK UFSD3.2 W18 LGAD (1.5e15 45 um 2x2 array) (Frontside TPA)

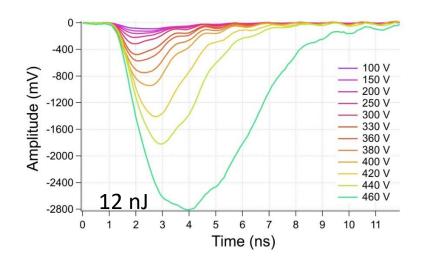


- To generate the signal comparable to 50 pJ SPA the pulse energy 17 nJ was used for TPA
- The signal and its evolution vs HV are very similar to SPA results.
- Similarly, to SPA the leak current jumps rapidly above 0.5 mA at 550V but not irreversible damage happens
- sensor works normally after decreasing bias below 550 V
- We didn't succeed to get any reasonable signal by backside illumination (metal mesh has to be removed)

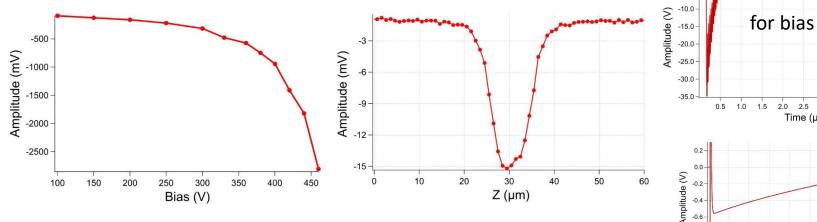


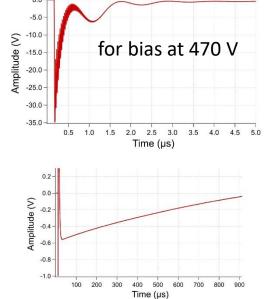


HPK-P1 W4 LGAD (1.5e15 35 um 2x2 array) (frontside TPA)

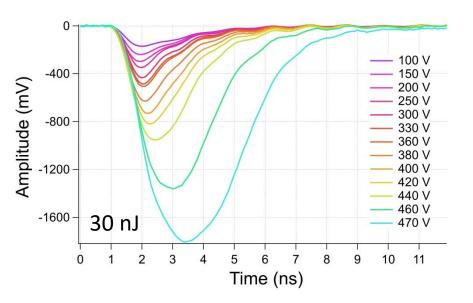


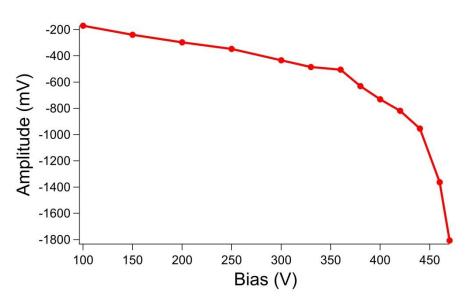
- To generate the signal comparable to 50 pJ SPA the pulse energy 12 nJ was used for TPA
- Signal is stable up to 460 V
- Above 460V signal starts jumping and extends to microsecond region
- at 480 V is too high to be measured
- We didn't push the bias further to save the sample for backside illumination test (see next slide)





HPK-P1 W4 LGAD (1.5e15 35 um 2x2 array) (backside TPA illumination)

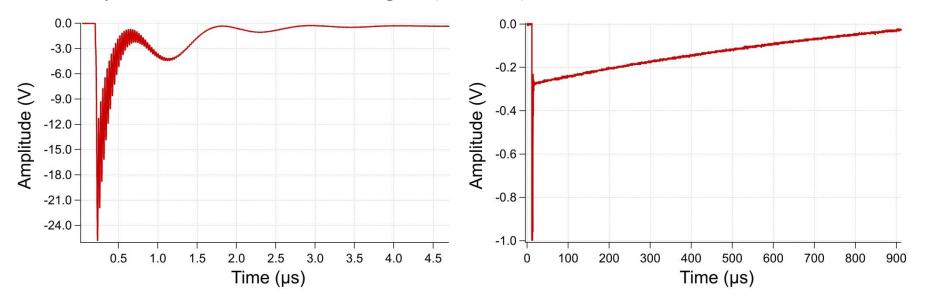




- To generate the signal comparable to front-TPA the pulse energy 30 nJ was used for backside illumination
- The signal and its evolution vs HV are very similar to front-TPA
- Signal is stable up to 470 V
- Above 470V signal starts jumping and extends to microsecond region
- above 480 V is too high to be measured

HPK-P1 W4 LGAD (1.5e15 35 um 2x2 array) (backside TPA illumination)

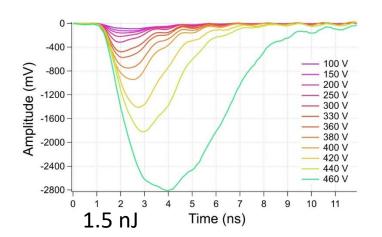
Example waveforms in unstable region (at 480 V)



This sensor is only one where we succeeded to get backside illumination TPA signal. There are some interesting observation:

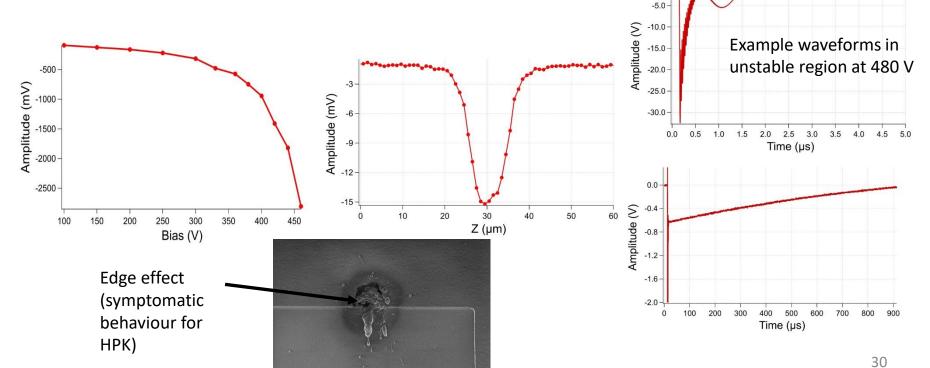
- in SPA a difference between laser power needed to generate the comparable signal by backside illumination was huge (3 orders of magnitude)
- here only slightly higher power (30 nJ vs 12 nJ) is needed to get comparable signal
- Z-scan for back-TPA gives clearly broader profile in comparison to front-TPA
- In spite of these differences, both cases (front and back-TPA gives very similar results in terms of the stability)

HPK-P1 W4 LGAD (2.25e15 35 um); single pad (frontside TPA)



- To generate the signal comparable to 50 pJ SPA the pulse energy 1.5 nJ was used for TPA (this is much less than for other sensors, no explanation for the moment)
- The signal and its evolution vs HV are similar to SPA results.
- Signal is stable up to 460 V
- Above 460V signal starts jumping and extends to microsecond region
- above 480 V is too high to be measured
- the bias was pushed further and the sensor broke down

irreversibly at 530 V.



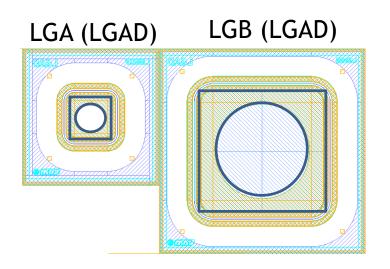
Conclusion

□ Sensor from different vendors have been studied (HPK, UFSD, CNM)
 SPA, TPA (Front, backside) was utilized
 □ Thickness – 35, 45, 50, 70 and 75 microns have been explored
 □ Results are in according with expectations
 □ CNM fatality studies at the place of illumination
 □ HPK at the metal/Si edge
 □ Thinner HPK -35 microns survived longer then we expected





Devices Run9254



Some of the LGA and LGB samples are not diced (they are stick together as the photo below shows). However they are short-circuited with regard to each other. One can be wirebond and measured while the other don't. The priority set by CNM was to test the mortality of the LGA samples (1.3x1.3mm, the small ones)

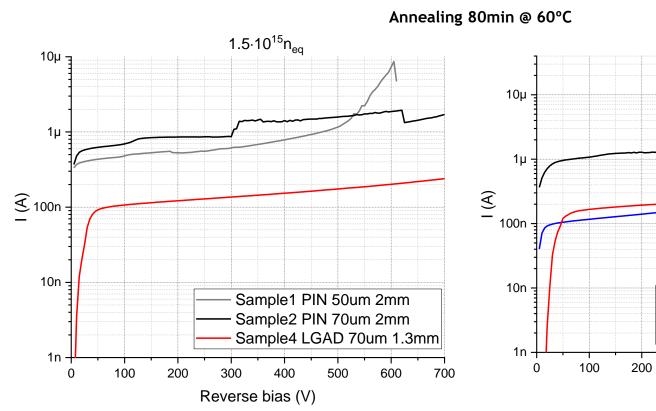


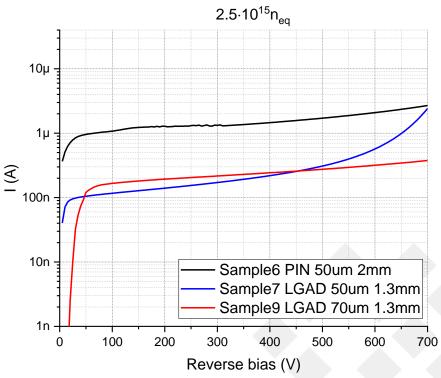
There are 6 housings and 10 devices. The priority is to test first the mortality of the 6 devices enlisted in the following slide (samples1, 2, 4, 6, 7 and 9)





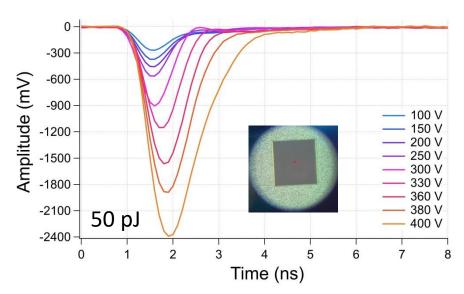
IV @ -20°C → Neutron irradiated samples to test → PRIORITY





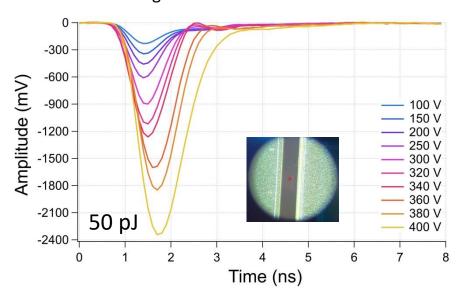
HPK-P1 W4 LGAD (2.25e15 35 um single pad) (comparison of opening window with guard ring)

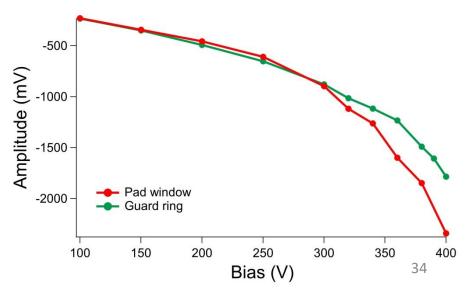
Opening window



- this sensor has nominal max. bias ~400 V
- the measurements in this range were performed for opening window and for the guard ring
- the results are nearly identical

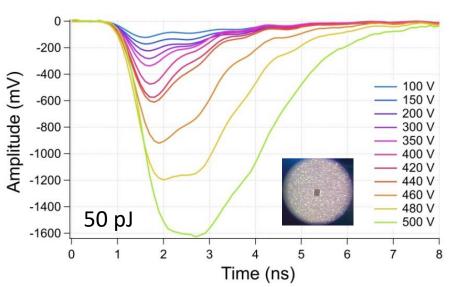






FBK UFSD3.2 W18 LGAD (1.5e15 45 um 2x2 array) (comparison of opening window with guard ring)

Opening window

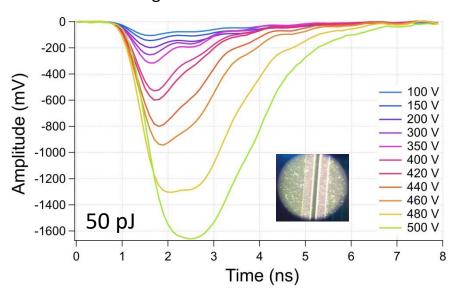


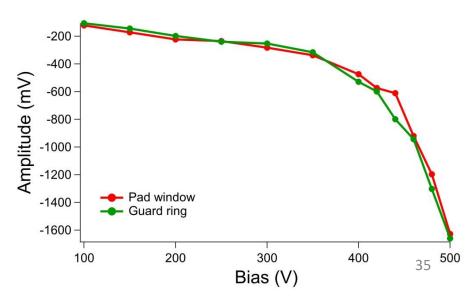
The opening window in FBK sensors are much smaller than in others but still big enough (~10x10 um) to safely focus the beam inside.

The response of the sensor was checked when illuminated in the guard ring region.

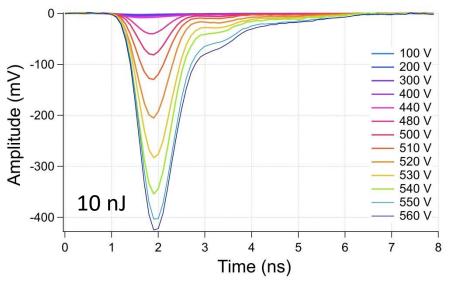
At exactly the same conditions the signal looks almost identical for window and ring. Leak current was also identical in both cases.



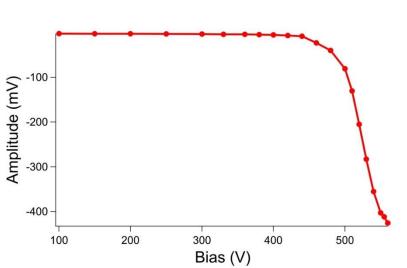


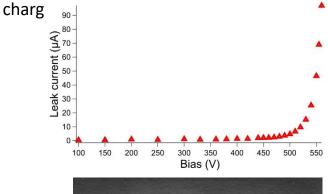


HPK-P1 W4 LGAD (2.5e15 35 um single pad) (backside illumination)



- to get a reasonable signal by illumination from the backside much higher pulse energy is necessary (10s of nJ regime)
- although nominal max. bias for this sensor is ~400 V it turned out that it can survive significantly higher voltage (at least 560 V)
- leak current jumps rapidly above 0.5 mA at 560V but not irreversible damage happens *not enough deposited





Edge fatality signature

